NSN 5962-00-004-0278

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View Online at https://aerobasegroup.com/nsn/5962-00-004-0278 **Body Length:** Between 1.200 inches and 1.290 inches **Body Width:** Between 0.515 inches and 0.580 inches **Body Height:** Between 0.050 inches and 0.230 inches **Maximum Power Dissipation Rating:** 650.0 milliwatts **Operating Tempurature Range:** -25.0/+70.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Hermetically sealed and monolithic and positive outputs and negative outputs and programmable and programmed and w/enable **Inclosure Material:** Ceramic and glass **Inclosure Configuration:** Dual-in-line **Output Logic Form:** P-type metal oxide-semiconductor logic **Input Circuit Pattern:** 11 input **Case Outline Source And Designator:** -0-015-aa joint electron device engineering council **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: -30.0 volts power source and 0.3 volts power source **Memory Device Type:** Rom **Memory Capacity:** Unknown **Test Data Document:** 31935-100337 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.; excludes any specification, standard or other document that may be referenced in a basic governing drawing) **Terminal Type And Quantity:** 24 printed circuit Shelf Life: N/a **Unit Of Measure:**

Demilitarization:

Yes - demil/mli

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